CMOS Digital Integrated Circuits Silicon Monolithic

TC7USB3212WBG

1. Functional Description

· Quad SPDT USB Switch

2. General

The TC7USB3212WBG is a 2 differential channel, 1-2 multiplexer/demultiplexer for USB3.0 (5Gbps), or other high-speed interface applications.

This device consists of four individual multiplexer/demultiplexer with common select input (SEL) and output enable (\overline{OE}) . The An+/An- inputs is connected to the Bn+/Bn- or Cn+/Cn- outputs determined by the combination both the select input (SEL) and output enable (\overline{OE}) . When the output enable (\overline{OE}) input is held high level, the switches are open with regardless the state of select inputs and a high-impedance state exists between the switches.

All inputs are equipped with protection circuits against static discharge.

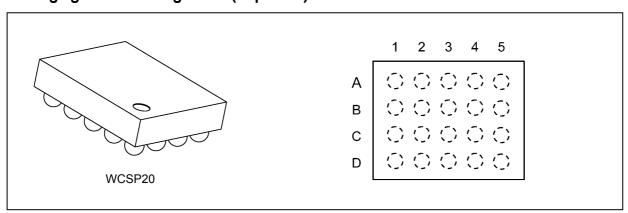
3. Features

- (1) Supply voltage: $V_{CC} = 1.65$ to 1.95 V
- (2) ON-resistance: $R_{ON} = 4.5 \Omega$ (typ.) @ $V_{CC} = 1.65 V$, $V_{IS} = 0 V$
- (3) -3dB Bandwidth: BW = 8 GHz (typ.) @V_{CC} = 1.8 V
- (4) Insertion Loss: IL = -1 dB (typ.) $@V_{CC} = 1.8 \text{ V}$, f = 2.5 GHz,
- (5) Power-down protection provided on all inputs and outputs.
- (6) Package: WCSP20

Note: Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

4. Packaging and Pin Assignment (Top View)



4.1. Pin Assignment

	1	2	3	4	5
Α	A0+	B0+	B0-	B1+	B1-
В	A0-	GND	GND	GND	V _{CC}
С	A1+	GND	GND	ŌE	SEL
D	A1-	C0+	C0-	C1+	C1-

Start of commercial production



5. Marking

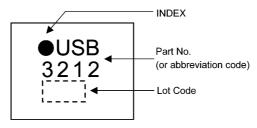


Fig. 5.1 Marking

6. System Diagram

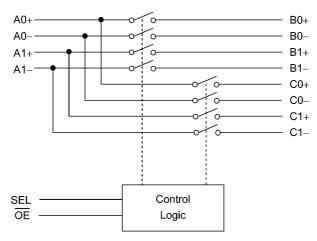


Fig. 6.1 Block Diagram

7. Principle of Operation

7.1. Truth Table

Input OE	Input SEL	Function			
L	L	An+ port = Bn+ port, An- Port = Bn- Port			
L	Н	An+ port = Cn+ port, An- Port = Cn- Port			
Н	Х	Disconnect			

X: Don't Care



8. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Test Condition Rating		Unit
Supply voltage	V _{CC}		_	-0.5 to 2.5	V
Input voltage (OE, SEL)	V _{IN}			-0.5 to 2.5	
Switch I/O voltage	Vs		V _{CC} = 0 V or Switch OFF	-0.5 to 2.5	
			Switch ON	-0.5 to V _{CC} +0.5	
Switch I/O current	I _S		_	45	mA
Power dissipation	P _D			210	mW
V _{CC} /ground current	I _{CC} /I _{GND}			±50	mA
Storage temperature	T _{stg}			-55 to 125	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

9. Operating Ranges (Note)

Characteristics	Symbol	Note	Test Condition Rating		Unit
Supply voltage	V _{CC}		_	1.65 to 1.95	V
Input voltage (OE, SEL)	V _{IN}			0 to 1.95	
Switch I/O voltage	Vs		V _{CC} = 0 V or Switch OFF	-0.35 to 1.95	
			Switch ON	-0.35 to V _{CC}	
Operating temperature	T _{opr}		_	-40 to 85	°C
Input rise time	dt/dv			0 to 10	ns/V
Input fall time				0 to 10	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either V_{CC} or GND.



10. Electrical Characteristics

10.1. DC Characteristics (Note) (Unless otherwise specified, T_a = -40 to 85°C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage (OE, SEL)	V _{IH}		_	1.65 to 1.95	0.75 × V _{CC}	_	_	V
Low-level input voltage (OE, SEL)	V _{IL}		_	1.65 to 1.95		_	0.35 × V _{CC}	
Input leakage current (OE, SEL)	I _{IN}		V _{IN} = 0 to 1.95 V	1.65 to 1.95		_	±5	μА
Power-OFF leakage current	I _{OFF}		V _{IN} = V _{IS} = 0 to 1.95 V	0	_	_	±20	
Switch OFF-state leakage current	I _{SZ}		$V_{IS} = 0$ to V_{CC} , $\overline{OE} = GND$	1.65 to 1.95		_	±5	
ON-resistance	R _{ON}	(Note 1)	V _{IS} = 0 V, I _{IS} = 30 mA	1.65	_	4.5	6	Ω
			V_{IS} = 0.5 V, I_{IS} = 30 mA	1.65	_	4.7	6.4	
			V _{IS} = 1.65 V, I _{IS} = 30 mA	1.65	_	7.5	13	
Difference of ON-resistance between switches	ΔR _{ON}	(Note 1)	V_{IS} = 0.5 V, I_{IS} = 30 mA (bit to bit)	1.65		0.1		
ON-resistance flatness	R _{ON(flat)}	(Note 1)	V _{IS} = 0 V to 1.0 V, I _{IS} = 30 mA	1.65		1.0		
Quiescent supply current	I _{CC}		$\frac{V_{IN}}{OE} = V_{CC}$ or GND $\frac{V_{CC}}{OE} = V_{CC}$	1.95	_	_	25	μА
			$\frac{V_{IN}}{OE} = V_{CC}$ or GND OE = GND		_	_	200	

Note: All typical values are at $T_a = 25$ °C.

Note 1: Measured by the voltage drop between An+/An- and Bn+/Bn-,Cn+/Cn- pins at the indicated current through the switch. On-resistance is determined by the lower of the voltages on the two pins.

10.2. AC Characteristics (Note) (Unless otherwise specified, T_a = -40 to 85°C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Propagation delay time	t _{PLH} /t _{PHL}	(Note 1)	C _L = 5 pF, See Fig. 11.1	1.8 ± 0.15	_	0.1	_	ns
Turn-ON time (SEL, OE to output)	t _{on}		R_L = 50 Ω , C_L = 5 pF, See Fig. 11.2		_	0.5	1	μS
Turn-OFF time (SEL, OE to output)	t _{off}				_	0.1	0.5	
Break before make	TBBM		$R_L = 50 \Omega$, $C_L = 5 pF$, See Fig. 11.3		200	_	700	ns
Output skew (bit to bit)	t _{SK(b)}	(Note 1)	C _L = 5 pF, See Fig. 11.4		_	1.5	_	ps
Output skew (channel to channel)	t _{SK(CH)}	(Note 1)	C _L = 5 pF, See Fig. 11.5			9.5		

Note: All typical values are at $T_a = 25$ °C. Note 1: Parameter guaranteed by design.

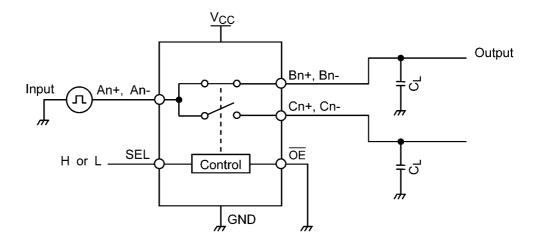
10.3. Analog Switch (Note) (Unless otherwise specified, T_a = -40 to 85°C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
OFF isolation (non-adjacent)	OIRR		R_T = 50 Ω , f = 2.5 GHz, See Fig. 11.6	1.8 ± 0.15	_	-30	_	dB
Crosstalk (non-adjacent)	Xtalk		$R_T = 50 \Omega$, f = 2.5 GHz, See Fig. 11.7		_	-25	_	
Insertion loss	IL		$R_T = 50 \Omega$, $f = 2.5 GHz$, See Fig. 11.8		_	-1	_	
-3dB Bandwidth	BW		R_T = 50 Ω , C_L = 0 pF, See Fig. 11.8		_	8	_	GHz

Note: All typical values are at $T_a = 25$ °C. Parameter guaranteed by design.



11. AC Test Circuits and Waveforms



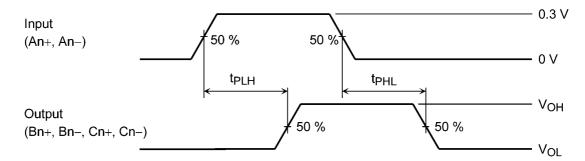
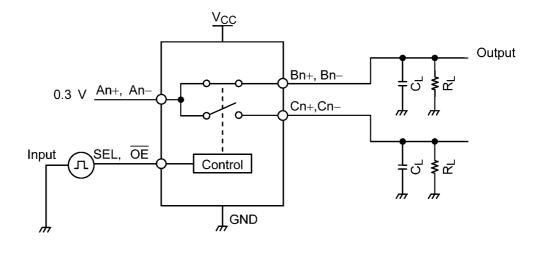


Fig. 11.1 Propagation Delay Time (t_{PLH}, t_{PHL})



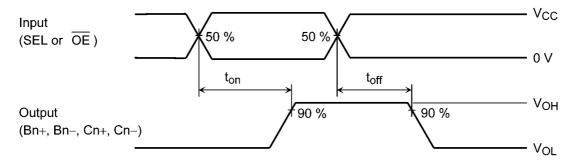


Fig. 11.2 Turn-ON and Turn-OFF Times (ton, toff)

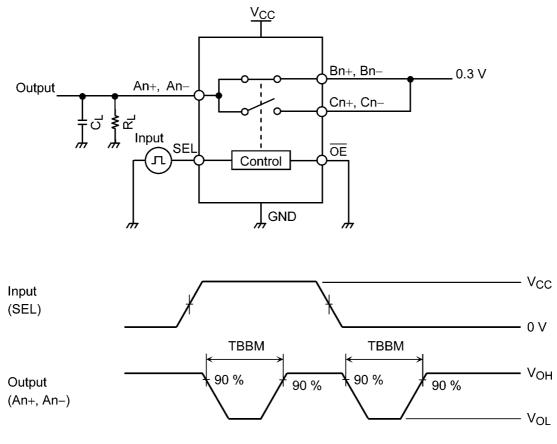
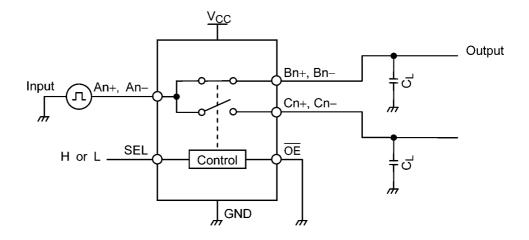


Fig. 11.3 Break Before Make (TBBM)



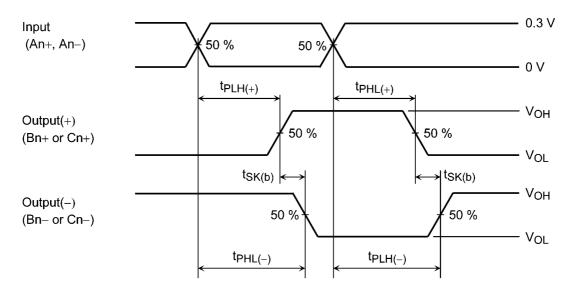


Fig. 11.4 Output Skew (bit to bit)

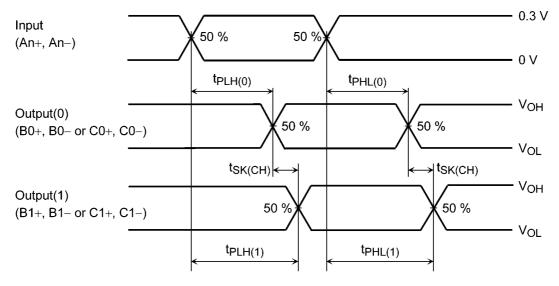
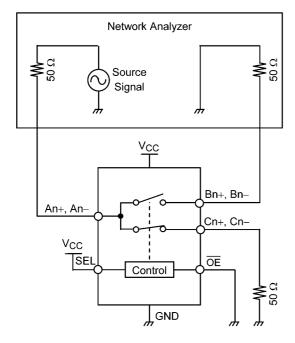
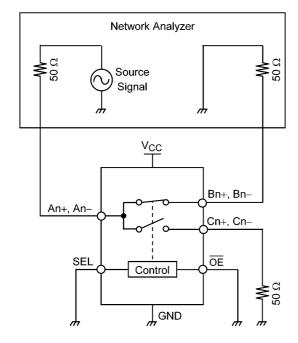


Fig. 11.5 Output Skew (channel to chnnel)



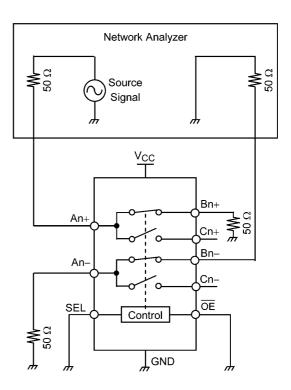
All unused ports are connected to GND through 50 Ω pull-down resistors.

Fig. 11.6 OFF Isolation



All unused ports are connected to GND through 50 Ω pull-down resistors.

Fig. 11.8 Insertion loss, -3dB Bandwidth



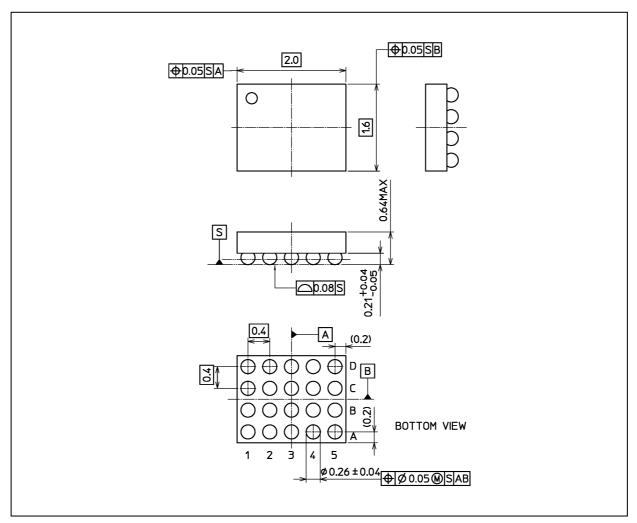
All unused ports are connected to GND through 50 Ω pull-down resistors.

Fig. 11.7 Crosstalk



Package Dimensions

Unit: mm



This resins used in this product include no flame retardants.

Weight: 0.005 g (typ.)

Package Name(s)
TOSHIBA: S-UFBGA20-0202-0.40-001
Nickname: WCSP20



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